### **General Description**

The MAX9169/MAX9170 low-jitter, low-voltage differential signaling LVDS/LVTTL-to-LVDS repeaters are ideal for applications that require high-speed data or clock distribution while minimizing power, space, and noise. The devices accept a single LVDS (MAX9169) or LVTTL (MAX9170) input and repeat the input at four LVDS outputs. Each differential output drives 100 $\Omega$ , allowing point-to-point distribution of signals on transmission lines with 100 $\Omega$  termination at the receiver input. The MAX9169 and MAX9170 are pin compatible with the SN65LVDS104 and SN65LVDS105, respectively, and offer improved pulse-skew performance.

Ultra-low 150ps (max) pulse skew and 200psp-p (max) added deterministic jitter ensure reliable communication in high-speed links that are highly sensitive to timing error, especially those incorporating clock-and-data recovery or serializers and deserializers. The highspeed switching performance guarantees 630Mbps data rate and less than 120ps channel-to-channel skew over the 3.0V to 3.6V operating supply range.

Supply current is 30mA (max) for the MAX9169, and 25mA (max) for the MAX9170. LVDS inputs and outputs conform to the ANSI EIA/TIA-644 standard. A fail-safe feature on the MAX9169 sets the output high when the input is undriven and open, terminated, or shorted. The MAX9169/MAX9170 are offered in 16-pin TSSOP and SO packages, and operate over an extended -40°C to +85°C temperature range.

Refer to the MAX9130 data sheet for an LVDS line receiver in an SC70 package.

### Applications

Point-to-Point Baseband Data Transmission

Cellular Phone Base Stations

Add/Drop Muxes

- **Digital Cross-Connects**
- Network Switches/Routers
- Backplane Interconnect
- Clock Distribution

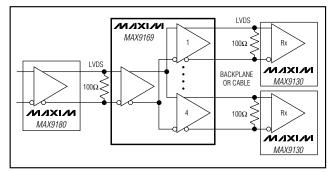
### **Features**

- 150ps (max) Pulse Skew
- 200psp-p (max) Added Deterministic Jitter at 630Mbps (2<sup>23</sup> - 1) PRBS Pattern
- 8ps<sub>RMS</sub> (max) Added Random Jitter
- 120ps (max) Channel-to-Channel Skew
- ♦ 630Mbps Data Rate
- ♦ Conforms to ANSI EIA/TIA-644 LVDS Standard
- 30mA (max) (MAX9169), 25mA (max) (MAX9170) Supply Current, a 15% Improvement vs. Competition
- LVDS (MAX9169) or +5V Tolerant LVTTL/LVCMOS (MAX9170) Input Versions
- Fail-Safe Circuit Sets Output High for Undriven Differential Input
- Output Rated for 10pF Load
- Individual Output Enables
- Single 3.3V Supply
- Improved Second Source of the SN65LVDS104 (MAX9169)/SN65LVDS105 (MAX9170)
- ♦ 16-Pin SO and TSSOP Packages

### **Ordering Information**

PART	TEMP RANGE	PIN- PACKAGE	INPUT
MAX9169ESE	-40°C to +85°C	16 SO	LVDS
MAX9169EUE	-40°C to +85°C	16 TSSOP	LVDS
MAX9170ESE	-40°C to +85°C	16 SO	LVTTL
MAX9170EUE	-40°C to +85°C	16 TSSOP	LVTTL

# **Typical Application Circuit**



Pin Configurations appear at end of data sheet.

## M/XI/M

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND	0.5V to +4V
Inputs	
IN+, IN- to GND	0.5V to +4V
IN, EN_ to GND	0.5V to +6V
Outputs	
OUT_+, OUT to GND	0.5V to +4V
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
16-Pin SO (derate 8.7mW/°C above +70°C	c)696mW

16-Pin TSSOP (derate 9.4mW/°C above +70°C) ........755mW

Storage Temperature Range	65°C to +150°C
Maximum Junction Temperature	+150°C
ESD Protection	
Human Body Model (MAX9169)	
(IN+, IN-, OUT_+, OUT)	≥16kV
Human Body Model (MAX9170)	
(OUT_+, OUT)	≥10kV
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **DC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = 3.0V \text{ to } 3.6V, R_L = 100\Omega \pm 1\%, EN_ = \text{high}, MAX9169 differential input voltage | V_{ID} | = 0.05V \text{ to } 1.2V, LVDS input common-mode voltage V_{CM} = | V_{ID}/2 | \text{ to } +2.4V - | V_{ID}/2 |, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, unless otherwise noted. Typical values are at V_{CC} = 3.3V, | V_{ID} | = 0.2V, V_{CM} = 1.25V, T_A = +25^{\circ}C \text{ for } MAX9169.$  Typical values are at V\_{CC} = 3.3V, V\_{IN} = 0 \text{ or } V\_{CC}, T\_A = +25^{\circ}C \text{ for } MAX9170. (Notes 1 and 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
LVDS INPUTS (IN+, IN-) (MAX916	59)						
Differential Input High Threshold	V <sub>TH</sub>			5	50	mV	
Differential Input Low Threshold	V <sub>TL</sub>		-50	-5		mV	
Input Current	lus lus	$V_{IN} = 0V$ , other input open, Figure 1	-2	-11.8	-20		
(IN+ or IN-, Single Ended)	I <sub>IN+</sub> , I <sub>IN-</sub>	V <sub>IN</sub> = +2.4V, other input open, Figure 1	-1.2	-3.2		μA	
Power-Off Input Current (IN+ or IN-, Single Ended)	I <sub>INO+</sub> , I <sub>INO-</sub>	$V_{CC}$ = +1.5V, $V_{IN}$ = +2.4V, other input open, Figure 1		3.2	20	μA	
		$0.05V \le  V_{ID}  \le 0.6V$ , Figure 1	-15		+15		
Input Current	I <sub>IN+</sub> , I <sub>IN-</sub>	0.6V <   V <sub>ID</sub>  ≤ 1.2V, Figure 1	-20		+20	μA	
Device Off laws to Overset		$0.05V \le  V_{ID}  \le 0.6V, V_{CC} = 1.5V, Figure 1$	-15		+15		
Power-Off Input Current	$\begin{array}{c} \text{IINO+, IINO-} \\ \hline 0.6V <  V_{\text{ID}}  \le 1.2V, V_{\text{CC}} \end{array}$	$0.6V <  V_{ID}  \le 1.2V, V_{CC} = 1.5V, Figure 1$	-20		+20	μA	
Fail-Safe Input Resistor	RIN1	V <sub>CC</sub> = 3.6V, 0 or open, Figure 1	103	138	190	kΩ	
	R <sub>IN2</sub>	V <sub>CC</sub> = 3.6V, 0 or open, Figure 1	154	210	260	K22	
Input Capacitance	CIN	IN+ or IN- to GND (Note 3)		2.2		pF	
+5V TOLERANT LVTTL/LVCMOS	S INPUTS (IN	, EN_)					
Input High Voltage	VIH		2.0		5.5	V	
Input Low Voltage	VIL		0		0.8	V	
Input Current	Iн	$V_{IN} = 2V$ to 5.5V			20		
Input Current	١ <sub>١L</sub>	$V_{IN} = 0$ to 0.8V			10	μA	
Input Capacitance (MAX9170)	CIN	IN to GND (Note 3)		2.2		pF	
LVDS OUTPUTS (OUT_+, OUT	)						
Differential Output Voltage	Vod	Figures 3, 4, 6, 7	250	350	450	mV	
Change in V <sub>OD</sub> Between Complementary Output States	$\Delta V_{OD}$	Figures 3, 4, 6, 7		1.5	25	mV	
Steady-State Output Offset Voltage	V <sub>OS</sub>	Figures 2, 4, 5, 7, 8, 9	1.125	1.26	1.375	V	



### DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = 3.0V \text{ to } 3.6V, R_L = 100\Omega \pm 1\%, EN_ = \text{high}, MAX9169 \text{ differential input voltage } | V_{ID} | = 0.05V \text{ to } 1.2V, LVDS input common-mode voltage } V_{CM} = | V_{ID}/2 | \text{ to } +2.4V - | V_{ID}/2 |, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{CC} = 3.3V, | V_{ID} | = 0.2V, V_{CM} = 1.25V, T_A = +25^{\circ}\text{C} \text{ for } MAX9169.$  Typical values are at  $V_{CC} = 3.3V, V_{IN} = 0$  or  $V_{CC}, T_A = +25^{\circ}\text{C}$  for MAX9169. Typical values are at  $V_{CC} = 3.3V, V_{IN} = 0$  or  $V_{CC}, T_A = +25^{\circ}\text{C}$  for MAX9170.) (Notes 1 and 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Change in V <sub>OS</sub> Between Complementary Output States	ΔV <sub>OS</sub>	Figures 2, 4, 5, 7, 8, 9			1.5	25	mV
Peak-to-Peak Output Offset Voltage	VOS(P-P)	Figures 8, 9 (Note 4)			40	150	mV
	VOH	Figures 3, 4, 6, 7	Figures 3, 4, 6, 7			1.65	V
Output Voltage	VOL	Figures 3, 4, 6, 7		0.9			V
Fail-Safe Differential Output Voltage (MAX9169)	V <sub>OD+</sub>	IN+, IN- open, undriven and sh undriven and parallel terminate		+250	+350	+450	mV
High-Impedance Output Current	I <sub>OZ</sub>	$EN_{-} = low, V_{OUT_{+}} = +3.6V \text{ or } 0,$ V_OUT = +3.6V or 0		-0.5	0.01	+0.5	μA
Power-Off Output Current	IOFF	$V_{CC} = +1.5V, V_{OUT_+} = +3.6V \text{ or } 0, V_{OUT} = +3.6V \text{ or } 0$		-0.5	0.01	+0.5	μA
Output Short-Circuit Current	IOS	$V_{ID} = +50mV \text{ or } -50mV,$ $V_{OUT+} = 0 \text{ or } V_{CC}, V_{OUT-} = 0 \text{ or } V_{CC}$		-10	±5.8	+10	mA
Magnitude of Differential Output Short-Circuit Current	IOSD	$V_{ID}$ = +50mV or -50mV, $V_{OD}$ = 0 (Note 5)			5.8	10	mA
Output Capacitance	Co	OUT_+ or OUT to GND (Note	e 6)		3.6		pF
POWER SUPPLY		•					
		DC, $R_L = 100\Omega$ ,	MAX9169		22	30	
Supply Current		Figures 10, 13	MAX9170		18	25	mA
	Icc	315MHz (630Mbps),	MAX9169		43	60	TTPA
		$R_L = 100\Omega$ , Figures 10, 13	MAX9170		41	55	
Disabled Supply Current	1007	EN_ = low MAX9169 MAX9170			6.8	8.0	mA
Disabled Supply Current	ICCZ				4.3	6.4	11174

### **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = 3.0V \text{ to } 3.6V, R_L = 100\Omega \pm 1\%, C_L = 10pF, EN_ = high, MAX9169 differential input voltage | V_{ID} | = 0.15V \text{ to } 1.2V, LVDS input common-mode voltage V_{CM} = | V_{ID}/2 | \text{ to } +2.4V - | V_{ID}/2 |, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, unless otherwise noted. Typical values are at | V_{ID} | = 0.2V, V_{CM} = 1.25V, V_{CC} = 3.3V, T_A = +25^{\circ}C \text{ for MAX9169}. Typical values are at V_{IN} = 0 \text{ or } V_{CC}, V_{CC} = 3.3V, T_A = +25^{\circ}C \text{ for MAX9169}. Typical values are at V_{IN} = 0 \text{ or } V_{CC}, V_{CC} = 3.3V, T_A = +25^{\circ}C \text{ for MAX9170.}$  (Notes 5, 7, and 8)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS	
Rise Time	t <sub>R</sub>	Figures 10–15		0.6	0.8	1.2	ns	
Fall Time	tF	Figures 10–15		0.6	0.8	1.2	ns	
Added Deterministic Jitter	t <sub>DJ</sub>	(Note 9)			110	200	ps	
Added Random Jitter	t <sub>RJ</sub>	(Note 10)			6	8	ps	
Differential Propagation Delay	t=	Figures 10, 11, 12, 14	MAX9169	2.2	3.5	4.2		
High to Low	<sup>t</sup> PHL	Figures 10, 11, 13, 14	MAX9170	1.5	2.6	3.2	ns	
Differential Propagation Delay	+		MAX9169	2.2	3.5	4.2	ns	
Low to High	<sup>t</sup> PLH	Figures 10, 11, 13, 14	MAX9170	1.5	2.6	3.2		
Pulse Skew  tPLH - tPHL	<b>t</b> SKEW	Figures 10, 11, 13, 14			40	250	ps	
Pulse Skew  tPLH - tPHL	tsk(P)	Figures 10, 12, 13, 15 (Note 11)			40	150	ps	
Channel-to-Channel Skew		MAX9169, Figures 10, 11, 12			25	120		
(Note 12)	tsk(0)	MAX9170, Figures 13, 14, 15			15	15 100 ps		
Differential Part-to-Part Skew		MAX9169, Figures 10, 11, 12			0.28	1.2		
(Note 13)	tsk(PP) MAX9170, Figures 13, 14, 15			0.19	1.2	ns		
	tphz	High to high-Z, Figures 16–19			11	15		
Disable Time tPLZ		Low to high-Z, Figures 16–19			11.8	15	ns	
Enable Time	t <sub>PZH</sub>	High-Z to high, Figures 16–19			2.3	10		
	tpzl	High-Z to low, Figures 16–19			5.8	10	ns	

**Note 1:** Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground except  $V_{TH}$ ,  $V_{TL}$ ,  $V_{ID}$ ,  $V_{OD}$ , and  $\Delta V_{OD}$ .

**Note 3:** Signal generator output for IN+, IN-, or single-ended IN:  $V_{IN} = 0.4 \sin(4E6\pi t) + 0.5$ .

Note 4: All input pulses are supplied by a generator having the following characteristics:  $t_R$  or  $t_F \le 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulsewidth = 500 ±10ns.

- Note 5: Guaranteed by design and characterization.
- **Note 6:** Signal generator output for OUT+ or OUT-:  $V_{IN} = 0.4 \sin(4E6\pi t) + 0.5$ , EN\_ = low.
- **Note 7:** C<sub>L</sub> includes scope probe and test jig capacitance.

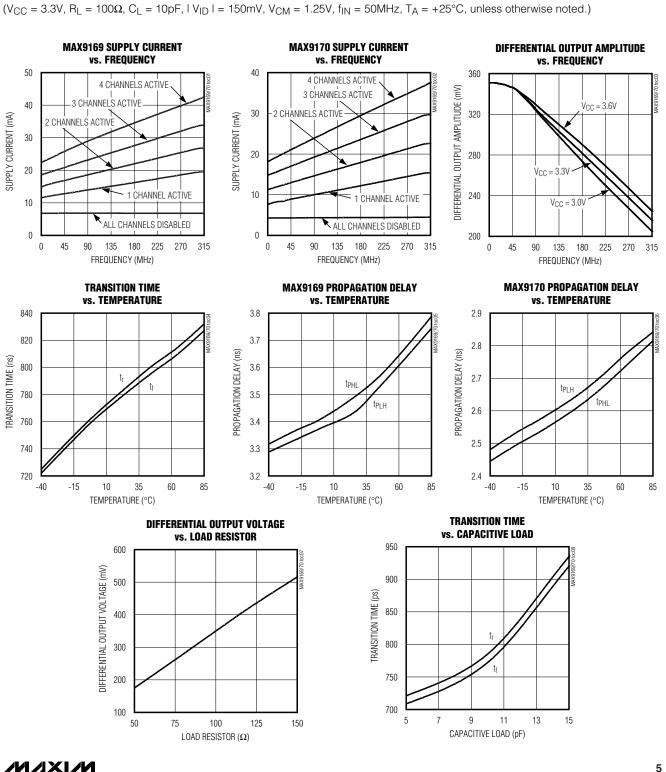
**Note 8:** Signal generator output for differential inputs IN+, IN- (unless otherwise noted): frequency = 50MHz, 49% to 51% duty cycle,  $R_O = 50\Omega$ ,  $t_R = 1.0ns$ , and  $t_F = 1.0ns$  (0% to 100%). Signal generator output for single-ended input IN (unless otherwise noted): frequency = 50MHz, 49% to 51% duty cycle,  $R_O = 50\Omega$ ,  $V_{IH} = V_{CC}$ ,  $V_{IL} = 0V$ ,  $t_R = 1.0ns$ , and  $t_F = 1.0ns$  (0% to 100%).

- **Note 9:** Signal generator output for MAX9169 (DJ:  $V_{OH} = +1.3V$ ,  $V_{OL} = +1.1V$ , data rate = 630Mbps,  $2^{23}$  -1 PRBS,  $R_O = 50\Omega$ ,  $t_R = 1.0$ ns and  $t_F = 1.0$ ns (0% to 100%). Signal generator output for MAX9170 t<sub>DJ</sub>:  $V_{OH} = V_{CC}$ ,  $V_{OL} = 0V$ , data rate = 630Mbps,  $2^{23}$  -1 PRBS,  $R_O = 50\Omega$ ,  $t_R = 1.0$ ns, and  $t_F = 1.0$ ns (0% to 100%).
- **Note 10:** Signal generator output for MAX9169 t<sub>RJ</sub>:  $V_{OH} = +1.3V$ ,  $V_{OL} = +1.1V$ , frequency = 315MHz, 50% duty cycle,  $R_O = 50\Omega$ , t<sub>R</sub> = 1.0ns, and t<sub>F</sub> = 1.0ns (0% to 100%). Signal generator output for MAX9170 t<sub>RJ</sub>:  $V_{OH} = V_{CC}$ ,  $V_{OL} = 0V$ , frequency = 315MHz, 50% duty cycle,  $R_O = 50\Omega$ , t<sub>R</sub> = 1.0ns, and t<sub>F</sub> = 1.0ns (0% to 100%).
- **Note 11:** Signal generator output for MAX9169  $t_{SK(P)}$ :  $V_{OH} = +1.4V$ ,  $V_{OL} = +1.0V$ ,  $R_O = 50\Omega$ ,  $t_R = 1.0$ ns, and  $t_F = 1.0$ ns (0% to 100%). Signal generator output for MAX9170  $t_{SK(P)}$ :  $V_{OH} = +3.0$ ,  $V_{OL} = 0V$ ,  $R_O = 50\Omega$ ,  $t_R = 1.0$ ns, and  $t_F = 1.0$ ns (0% to 100%).
- Note 12:  $t_{SK(0)}$  is the magnitude of the time difference between  $t_{PLH}$  or  $t_{PHL}$  of all drivers of a single device with all of their inputs connected together.
- Note 13: t<sub>SK(PP)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.



Note 2: Maximum and minimum limits over temperature are guaranteed by design and characterization. Devices are production tested at  $T_A = +25^{\circ}C$ .

**Typical Operating Characteristics** 



### **Pin Description**

PIN			FUNCTION
MAX9169	MAX9170	NAME	FUNCTION
1	1	EN1	OUT1+/OUT1- Enable. +5V tolerant LVTTL/LVCMOS input. Set EN1 high to enable OUT1+/OUT1 Set EN1 low to disable OUT1+/OUT1- (high-impedance mode). Integrated pulldown to GND.
2	2	EN2	OUT2+/OUT2- Enable. +5V tolerant LVTTL/LVCMOS input. Set EN2 high to enable OUT2+/OUT2 Set EN2 low to disable OUT2+/OUT2- (high-impedance mode). Integrated pulldown to GND.
3	3	EN3	OUT3+/OUT3- Enable. +5V tolerant LVTTL/LVCMOS input. Set EN3 high to enable OUT3+/OUT3 Set EN3 low to disable OUT3+/OUT3- (high-impedance mode). Integrated pulldown to GND.
4	4	V <sub>CC</sub>	Power-Supply Voltage. Bypass with 0.1µF and 0.001µF capacitors to ground.
5	5	GND	Ground
6	_	IN+	Noninverting Differential LVDS Input
7	_	IN-	Inverting Differential LVDS Input
8	8	EN4	OUT4+/OUT4- Enable. +5V tolerant LVTTL/LVCMOS input. Set EN4 high to enable OUT4+/OUT4 Set EN4 low to disable OUT4+/OUT4- (high-impedance mode). Integrated pulldown to GND.
9	9	OUT4-	Inverting Differential LVDS Output
10	10	OUT4+	Noninverting Differential LVDS Output
11	11	OUT3-	Inverting Differential LVDS Output
12	12	OUT3+	Noninverting Differential LVDS Output
13	13	OUT2-	Inverting Differential LVDS Output
14	14	OUT2+	Noninverting Differential LVDS Output
15	15	OUT1-	Inverting Differential LVDS Output
16	16	OUT1+	Noninverting Differential LVDS Output
_	6	IN	Data Input, 5V Tolerant LVTTL/LVCMOS. Integrated pulldown to GND.
—	7	N.C.	No Connection

INPUT	OUTPUT				
$V_{ID} = V_{IN+} - V_{IN-}$	EN_	V <sub>OD</sub>			
Х	Low or open	High-Z			
+50mV	High	High			
-50mV	High	Low			
Open	High	High			
Undriven short	High	High			
Undriven parallel terminated	High	High			

### Table 1. MAX9169 Input/Output Functions Table 2. MAX9170 Input/Output Functions

INF	INPUT		
V <sub>IN</sub>	V <sub>IN</sub> EN_		
Х	Low or open	High-Z	
High	High	High	
Low	High	Low	
Open	High	Low	

### **Detailed Description**

LVDS is a signaling method for point-to-point and multidrop data communication over a controlled-impedance medium as defined by the ANSI TIA/EIA-644 and IEEE 1596.3 standards. LVDS uses a lower voltage swing than other common standards, achieving higher data rates with reduced power consumption, while reducing EMI emissions and system susceptibility to noise.

The MAX9169/MAX9170 are 630Mbps, four-port repeaters for high-speed, low-power applications. The MAX9169 accepts an LVDS input and has a fail-safe input circuit. The MAX9170 features a +5V tolerant single-ended LVTTL/LVCMOS input. Both devices repeat the input at four LVDS outputs. The MAX9169 detects differential signals as low as 50mV and as high as 1.2V over a  $IV_{ID}I/2$  to 2.4V -  $IV_{ID}I/2$  common-mode range. The MAX9170's +5V tolerant LVTTL/LVCMOS input includes circuitry to hold the decision threshold constant at +1.5V over temperature and supply voltage.

The MAX9169/MAX9170 outputs use a current-steering configuration to generate a 2.5mA to 4.5mA output current. This current-steering approach induces less ground bounce and shoot-through current, enhancing noise margin and system speed performance. The outputs are short-circuit current limited and are high impedance when disabled or when the device is not powered.

The MAX9169/MAX9170 current-steering output requires a resistive load to terminate the signal and complete the transmission loop. Because the devices switch the direction of current flow and not voltage levels, the output voltage swing is determined by the value of the termination resistor multiplied by the output current. With a typical 3.5mA output current, the MAX9169/MAX9170 produce a 350mV output voltage when driving a transmission line terminated with a 100 $\Omega$  resistor (3.5mA × 100 $\Omega$  = 350mV). Logic states are determined by the direction of current flow through the termination resistor.

#### Fail-Safe Circuitry

The fail-safe feature of the MAX9169 sets the outputs high when the differential input is:

- Open
- Undriven and shorted
- Undriven and terminated

Without a fail-safe circuit, when the input is undriven, noise at the input may switch the outputs and it may appear to the system that data is being sent. Open or undriven terminated input conditions can occur when a cable is disconnected or cut, or when an LVDS driver output is in high impedance. A shorted input can occur because of cable failure.



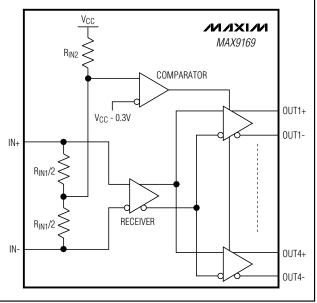


Figure 1. MAX9169 Input Fail-Safe Circuit

When the input is driven with signals meeting the LVDS standard, the input common-mode voltage is less than  $V_{CC}$  - 0.3V and the fail-safe circuit is not activated (Figure 1). If the input is open, undriven and shorted, or undriven and parallel terminated, an internal resistor in the fail-safe circuit pulls both the inputs above  $V_{CC}$  - 0.3V, activating the fail-safe circuit and forcing the outputs high.

### Applications Information

#### Supply Bypassing

Bypass V<sub>CC</sub> with high-frequency surface-mount ceramic  $0.1\mu$ F and  $0.001\mu$ F capacitors in parallel as close to the device as possible, with the smaller value capacitor closest to the V<sub>CC</sub> pin. Use multiple parallel vias to minimize parasitic inductance.

#### **Traces, Cables, and Connectors**

The characteristics of differential input and output connections affect the performance of the MAX9169/ MAX9170. Use controlled-impedance traces, cables, and connectors with matched characteristic impedance.

Ensure that noise couples as common mode by running the traces of a differential pair close together. Reduce within-pair skew by matching the electrical length of the traces of a differential pair. Excessive skew can result in a degradation of magnetic field cancellation. Maintain a constant distance between traces of a differential pair to avoid discontinuities in differen-

tial impedance. Minimize the number of vias to further prevent impedance discontinuities.

Avoid the use of unbalanced cables, such as ribbon cable. Balanced cables, such as twisted pair, offer superior signal quality and tend to generate less EMI due to canceling effects. Balanced cables tend to pick up noise as common mode, which is rejected by the LVDS receiver.

#### Termination

The MAX9169/MAX9170 LVDS outputs are specified for a 100 $\Omega$  load but can drive 90 $\Omega$  to 132 $\Omega$  to accommo-

date various types of interconnect. The termination resistor at the driven receiver should match the differential characteristic impedance of the interconnect and be located close to the receiver input. Use a  $\pm 1\%$  surface-mount termination resistor.

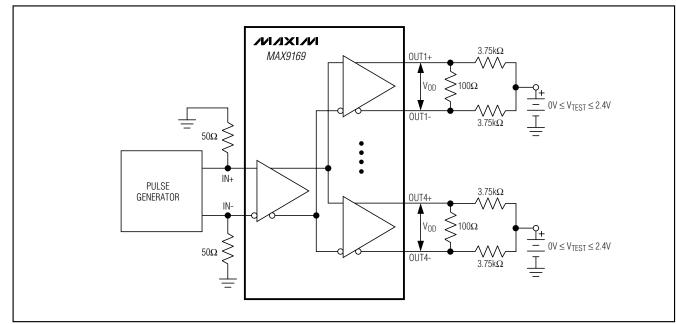
#### **Board Layout**

A four-layer PC board with separate layers for power, ground, and LVDS signals is recommended. Keep LVTTL/LVCMOS signals separated from the LVDS signals to prevent crosstalk to the LVDS lines.

**Test Circuits and Timing Diagrams** 

#### /M/IXI/M • OUT1+ MAX9169 $50\Omega$ 10pF 0 Vos 500 $_{50\Omega} \lesssim$ -0 OUT1-10pF IN+ •OUT4+ PULSE GENERATOR 50Ω IN-10pF -Vos $\leq$ 50Ω 50Ω • OUT4-10pF

Figure 2. MAX9169 Output Offset Voltage Test Circuit



### Test Circuits and Timing Diagrams (continued)

Figure 3. MAX9169 Differential Output Voltage Test Circuit

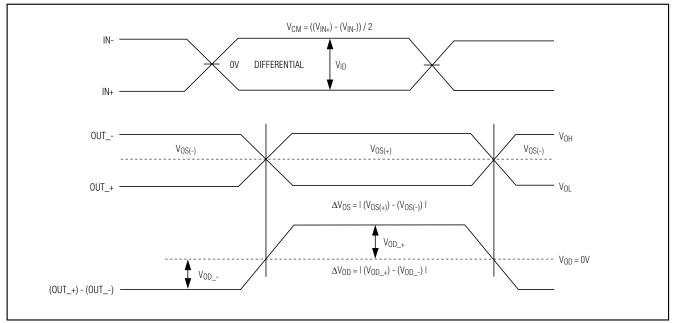


Figure 4. MAX9169 Output DC Parameters

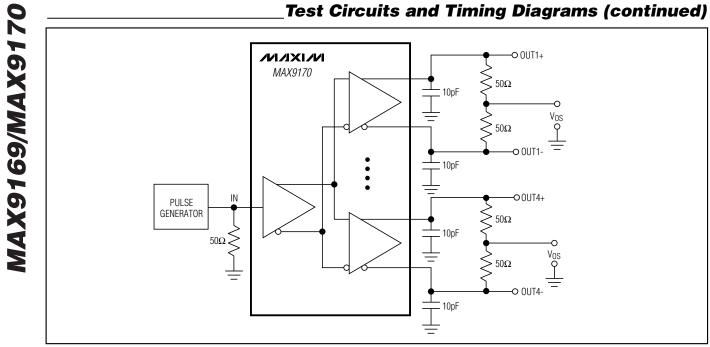


Figure 5. MAX9170 Output Offset Voltage Test Circuit

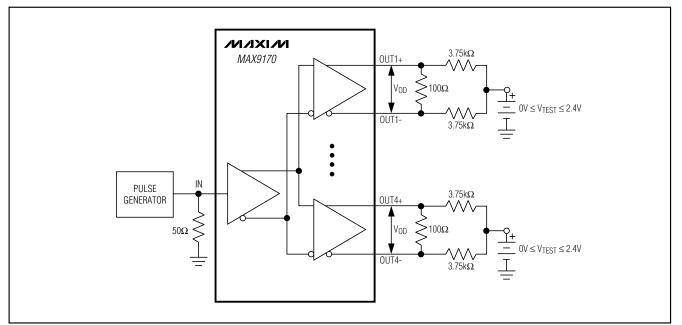
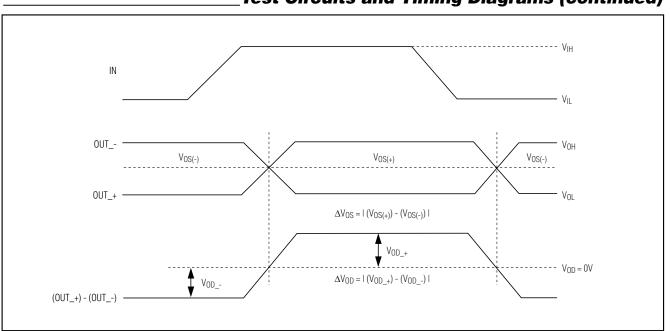


Figure 6. MAX9170 Differential Output Voltage Test Circuit

10



# \_\_\_Test Circuits and Timing Diagrams (continued)

Figure 7. MAX9170 LVDS Output DC Parameters

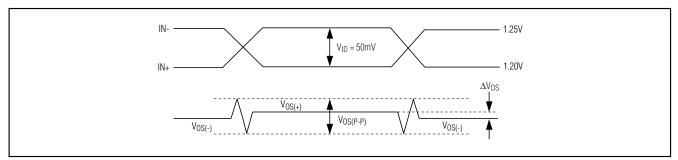


Figure 8. MAX9169 Output Offset Voltage Waveforms

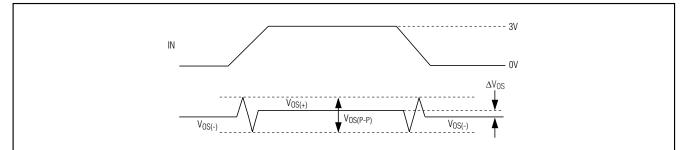


Figure 9. MAX9170 Output Offset Voltage Waveforms

11

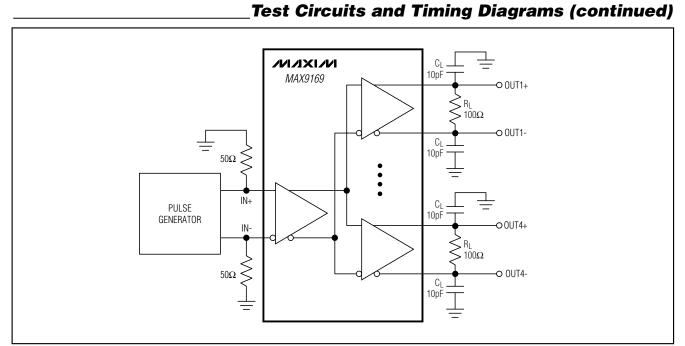


Figure 10. MAX9169 Propagation Delay and Transition Time Test Circuit

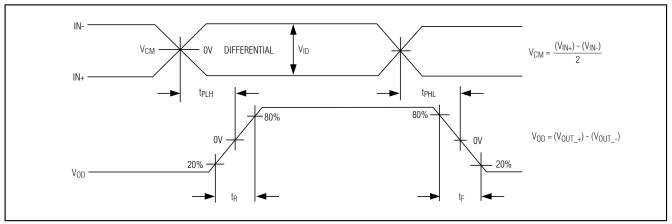
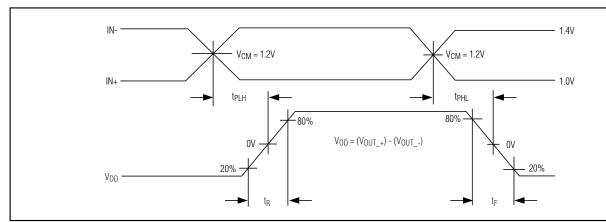


Figure 11. MAX9169 Propagation Delay and Transition Time Waveforms



## \_Test Circuits and Timing Diagrams (continued)

Figure 12. MAX9169 Propagation Delay and Transition Time Waveforms, t<sub>SK(p)</sub>

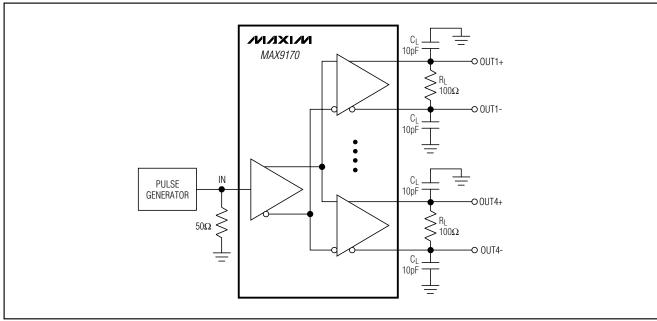


Figure 13. MAX9170 Propagation Delay and Transition Time Test Circuit

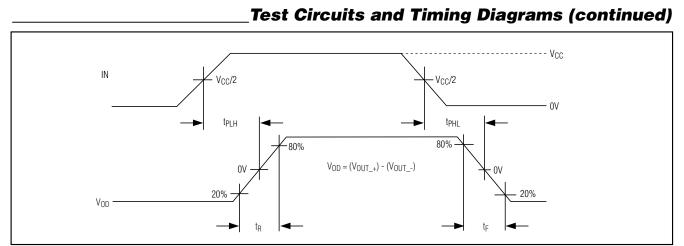


Figure 14. MAX9170 Propagation Delay and Transition Time Waveforms

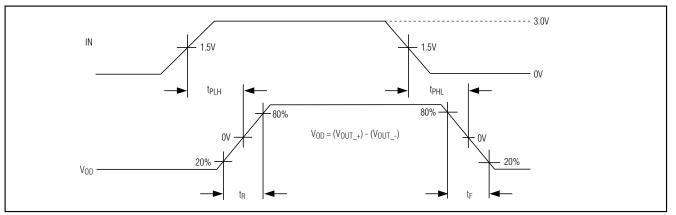
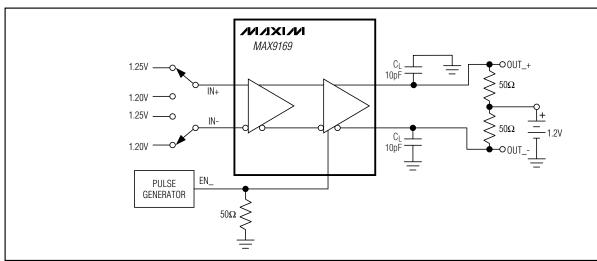


Figure 15. MAX9170 Propagation Delay and Transition Time Waveforms, tSK(p)



### \_Test Circuits and Timing Diagrams (continued)

Figure 16. MAX9169 Enable and Disable Time Test Circuit

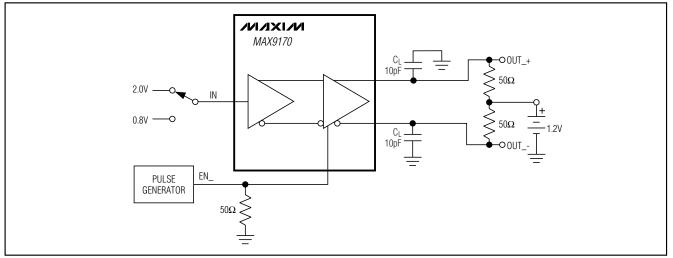


Figure 17. MAX9170 Enable and Disable Time Test Circuit

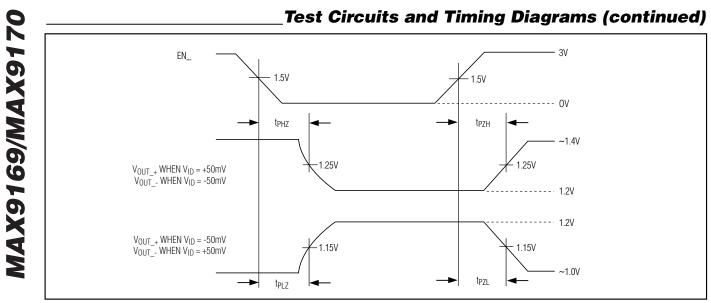


Figure 18. MAX9169 Enable and Disable Time Waveforms

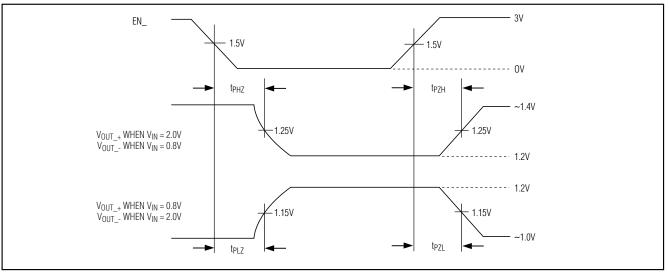
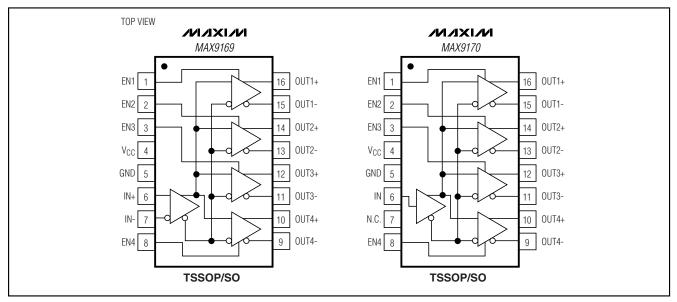


Figure 19. MAX9170 Enable and Disable Time Waveforms



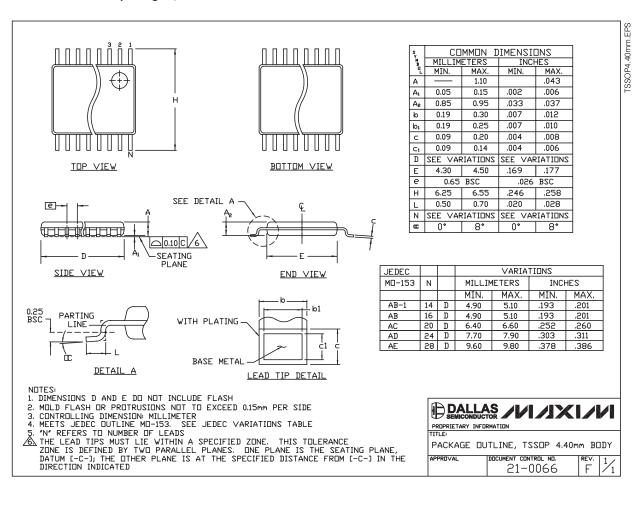
## Pin Configurations

### Chip Information

TRANSISTOR COUNT: 1187 PROCESS: CMOS

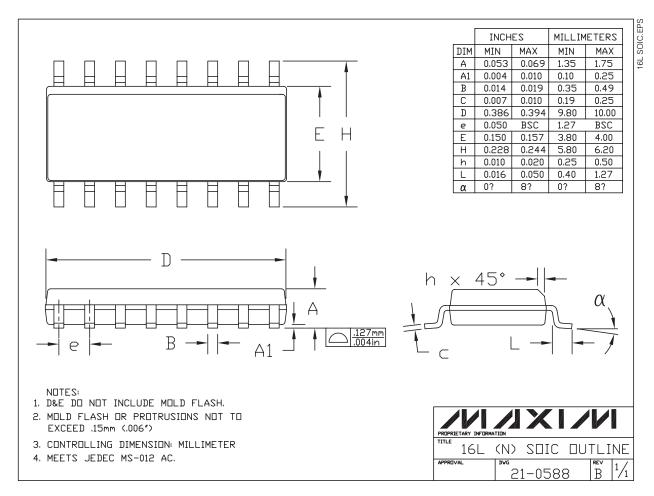
### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



MAX9169/MAX9170

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600 \_\_\_\_

© 2002 Maxim Integrated Products Printed USA MAXIM is a registered trademark of Maxim Integrated Products.

\_ 19

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Interface - Signal Buffers, Repeaters category:

Click to view products by Maxim manufacturer:

Other Similar products are found below :

PI6ULS5V9509UEX PI3HDMI101-BZHEX PI3EQX12904AZHEX PI6ULS5V9306WEX PI3EQX1004EZTFEX PI6ULS5V9509WEX 48705-3001R2 48705-6501R2 DS280BR820ZBLT PCA9617ADPJ PI6ULS5V9515AWEX PI3HDMI101ZHE P82B715TD.112 LTC4315CDE#PBF LTC4300-1CMS8#PBF DS110DF1610FB/NOPB LTC4301LCDD#PBF LTC4303IDD#PBF LTC4315IMS#TRPBF LTC4304IMS#PBF DS280DF810ABVT LTC4313IDD-3#PBF LTC4315IDE#PBF LTC4300-1IMS8#PBF LTC4313IMS8-3#TRPBF LTC4300-2IMS8#PBF LTC4300A-1CMS8#PBF P82B96TDS900,118 PCA9515AD,118 LTC4307CMS8-1#TRPBF LTC4304CDD#PBF PI3EQX1002B1ZLEX LTC4301LIMS8 LTC4313IDD-3#TRPBF LTC4309IGN#PBF LTC4309CGN#PBF MAX9169EUE+ LTC4302IMS-2#PBF LTC4302CMS-1#PBF PI6ULS5V9306UEX LTC4300A-1CMS8#TRPBF P82B715TD,112 PCA9507DP,118 PCA9509DP,118 PCA9509GM,125 PCA9515ADP,118 PCA9517AD,118 PCA9517ADP,118 PCA9517DP,118 P82B715TD,112